

Schottky Barrier Diode Silicon Epitaxial

# **CUS357**

#### 1. Applications

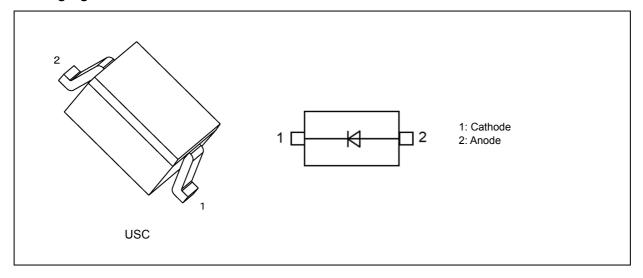
· High-Speed Switching

#### 2. Features

- (1) AEC-Q101 qualified (Note 1)
- (2) Low forward voltage :  $V_{F(3)} = 0.54 \text{ V (typ.)}$
- (3) Low reverse current :  $I_{R(1)} = 1\mu A \text{ (max)}$
- (4) General purpose USC package, equivalent to SOD-323 and SC-76 packages

Note 1: For detail information, please contact our sales.

#### 3. Packaging and Internal Circuit



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#### 4. Absolute Maximum Ratings (Note) (Unless otherwise specified, T<sub>a</sub> = 25 °C)

| Characteristics                           | Symbol           | Note     | Rating     | Unit |
|---|------------------|----------|------------|------|
| Peak reverse voltage                      | $V_{RM}$         |          | 45         | V    |
| Reverse voltage                           | V <sub>R</sub>   |          | 40         |      |
| Peak forward current                      | I <sub>FM</sub>  |          | 300        | mA   |
| Average rectified current                 | Io               |          | 100        | mA   |
| Power dissipation                         | P <sub>D</sub>   | (Note 1) | 200        | mW   |
| Non-repetitive peak forward surge current | I <sub>FSM</sub> | (Note 2) | 1          | Α    |
| Junction temperature                      | Tj               |          | 125        | °C   |
| Storage temperature                       | T <sub>stg</sub> |          | -55 to 125 | °C   |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on a glass epoxy circuit board of 20 mm × 20 mm, Pad dimension of 4 mm × 4 mm.

Note 2: Pulse width 10 ms

#### 5. Electrical Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)

| Characteristics   | Symbol            | Test Condition                  | Min | Тур. | Max  | Unit |
|-------------------|-------------------|---------------------------------|-----|------|------|------|
| Forward voltage   | V <sub>F(1)</sub> | I <sub>F</sub> = 1 mA           |     | 0.21 |      | V    |
| Forward voltage   | V <sub>F(2)</sub> | I <sub>F</sub> = 10 mA          |     | 0.30 |      | ٧    |
| Forward voltage   | V <sub>F(3)</sub> | I <sub>F</sub> = 100 mA         |     | 0.54 | 0.60 | V    |
| Reverse current   | I <sub>R(1)</sub> | V <sub>R</sub> = 10 V           |     | _    | 1    | μΑ   |
| Reverse current   | I <sub>R(2)</sub> | V <sub>R</sub> = 40 V           |     | _    | 5    | μΑ   |
| Total capacitance | Ct                | V <sub>R</sub> = 0 V, f = 1 MHz |     | 11   |      | pF   |

#### 6. Marking

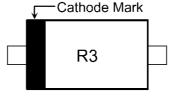


Fig. 6.1 Marking

| Marking Code | Part Number |  |  |  |
|--------------|-------------|--|--|--|
| R3           | CUS357      |  |  |  |



#### 7. Usage Considerations

Schottky barrier diodes (SBDs) have reverse leakage greater than other types of diodes. This makes SBDs more susceptible to thermal runaway under high-temperature and high-voltage conditions. Thus, both forward and reverse power losses of SBDs should be considered for thermal and safety design.

# 8. Land Pattern Dimensions (for reference only)

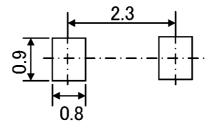
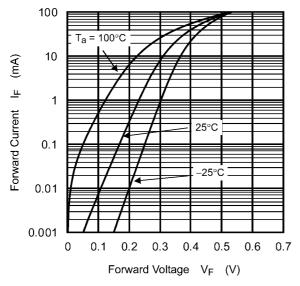


Fig. 8.1 Land Pattern Dimensions for Reference Only (Unit: mm)



### 9. Characteristics Curves (Note)





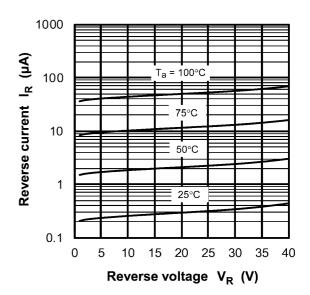


Fig. 9.2  $I_R - V_R$ 

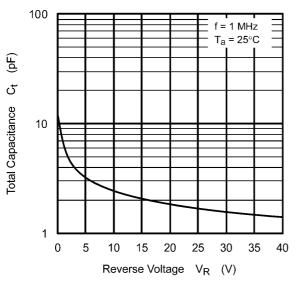


Fig. 9.3 Ct - VR

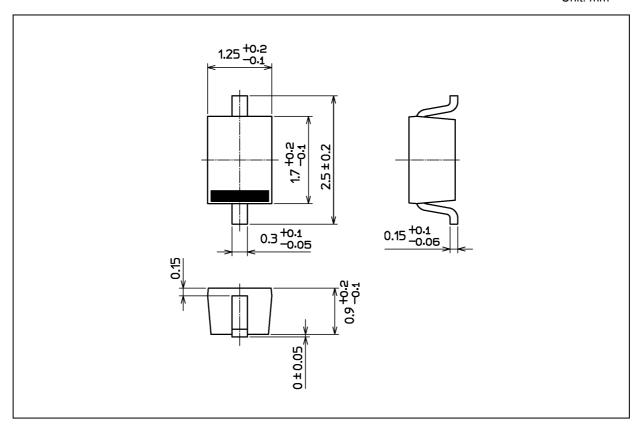
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

2023-07-08



# **Package Dimensions**

Unit: mm



Weight: 4.5 mg (typ.)

| Pa              | ackage Name(s) |
|-----------------|----------------|
| TOSHIBA: 1-1E1S |                |
| Nickname: USC   |                |



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